## The History of SEL Technology

2016



High Power 2D VCSEL Arrays for 3D Sensing General Availability 10G and 25G SWDM VCSELs General Availability Single Mode VCSELs for Consumer and Scientific Applications Introduced



2015

56G+ NRZ Demonstration with IBM 940nm High Power 2D VCSEL Arrays Introduced for Consumer Applications 10G and 25G SWDM VCSELs Introduced



2014



Next Generation 10G VCSEL Demonstrated with 95°C Temperature Operation 16G VCSEL Released to Mass Production 25G 850nm VCSEL Introduced

2013

850nm High Power 2D VCSEL Arrays Introduced for Consumer Applications

2012



High Powered VCSELs; 980nm VCSELs; Chip on Flex TOSA

Finisar introduced high powered VCSELs targeting Gesture Recognition and 3D imaging and also packaging capabilities like Chip on Flex, Chip on Board, and Chip on lead-frame.

2011



Finisar introduced several new VCSELs for diversifying into many different markets. Finisar now has single mode and multi-mode VCSELs that cover 780nm to 1050nm wavelength range and speeds up to 25 Gbps.



2010

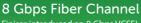


16 Gbps Fiber Channel

Finisar introduced the 14-16 Gbps VCSEL based on Oxide Isolated VCSEL technology.



2007



Finisar introduced an 8 Gbps VCSEL based on Oxide Isolated VCSEL technology.



2006(



Finisar Opens New Manufacturing Plant

Finisar Opens New Manufacturing Plant in Allen, Texas to support increasing VCSEL demand.



2005

components using laser chips. These components were enablers in many applications like label printers, coin detectors in

Reflective Sensor

10 Gbps

2004

Finisar Acquires Honeywell VCSEL Group

The Honeywell VCSEL group was acquired by Finisar in March of 2004 as part of its vertical integration strategy.

Continuing with the endeavor to look for additional VCSEL-based businesses, Finisar marketed TO-46 can based sensor

Honeywell

2003

4 Gbps

Finisar introduced a 4 Gbps VCSEL based on Oxide Isolated VCSEL technology.

2002

**STABILAZE™** 

Finisar established the trade name Stabilaze for the world's first VCSEL devices that were burned-in for performance stabilization in wafer form. Finisar holds a patent for this technology and is still the only company in the world to successfully burn-in VCSELs in wafer form. This has also contributed to setting the Finisar VCSEL apart from the competition.

2001

Single Mode VCSEL

Finisar introduced its first single mode VCSEL in 2001. This was an 850nm VCSEL and marked the initial effort to look for applications outside of the traditional datacom market. This product was designed into a high-end encoder application and still ships in volume today. Again, Finisar reliability was key to the success of this product.

2000

Oxide VCSEL; Reliability Paper; 1x4 and 1x12 Arrays

Finisar introduced its first oxide VCSEL capable of 2.5 Gbps. In conjunction, Finisar published the data in a world-class reliability paper reinforcing the company's reputation for reliable VCSELs. Finisar also introduced the world's first 1x4 and 1x12 VCSEL arrays demonstrating robustness in

1998

**VCSEL TOSA** 

Finisar introduced TOSA and ROSA components designed specifically for easier integration into



1996

First Commercial Product; Industry First Reliability Paper standard in the industry for reliability. This first paper by Honeywell was the foundation for that reputation.

1995

**VCSEL Production Transferred to Texas** 

The VCSEL technology was moved to the Semiconductor Fab in Richardson, Texas to enable production support of the VCSELs. This initial VCSEL device capable of modulation up to 1 Gbps was based on Proton Implanted technology.



1993

Research Begins at Honeywell Technology Center

VCSEL research starts at Honeywell and a new group is established in Minneapolis, MN. In 1996, this group was the first to commercialize VCSELs and the development continued here until the early 2000's when R&D was moved to Richardson, Texas



